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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re patent application of:

Applicant: Dong-Hyuk Ju et al.

Serial No: 09/879,724

Filing Date: June 12, 2001

Art Unit: 2826

Examiner: Ahmed N. Sefer

Title: **LEAKY, THERMALLY CONDUCTIVE INSULATOR MATERIAL (LTCIM) IN SEMICONDUCTOR-ON-INSULATOR (SOI) STRUCTURE**

Commissioner for Patents  
U.S. Patent and Trademark Office  
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**REPLY TO OFFICE ACTION DATED JANUARY 22, 2002**

Dear Sir:

This paper is responsive to the written restriction requirement dated January 22, 2002.